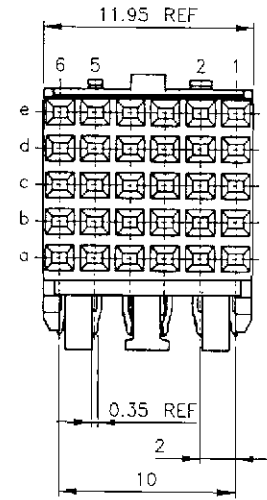
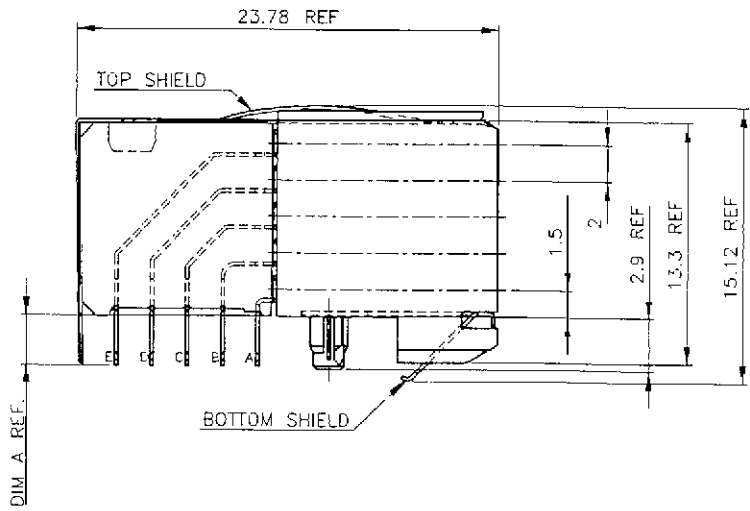
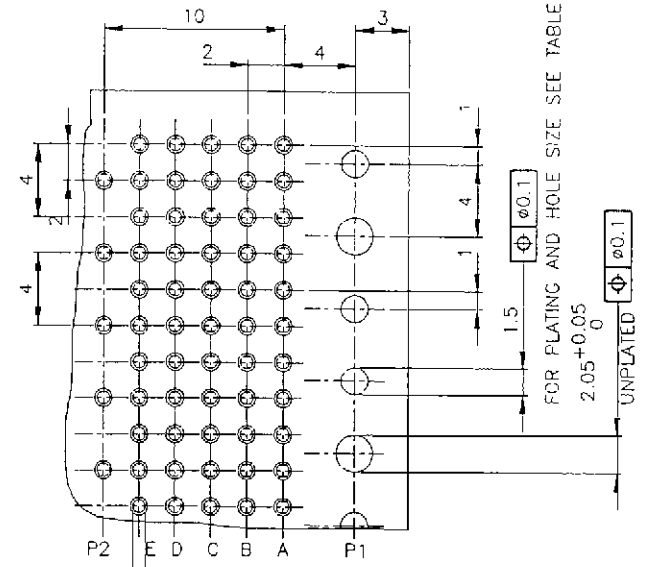
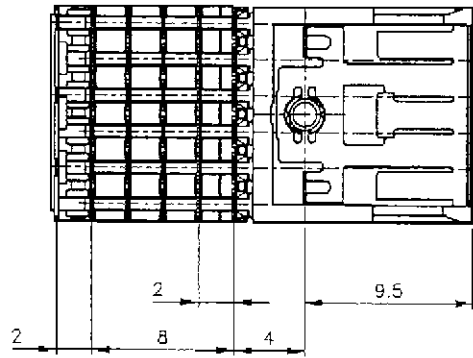


PRODUCT NR:	REMARK:
85847-X02	DIM A: 2.73
85847-X12	CUSTOMER SPECIAL



PRESS-FIT HOLES	A; B; C; D; E; P2	P1
HOLE DIAMETER AFTER PLATING	0.65 - 0.80	1.50 - 1.60
DRILLED HOLE	0.81 - 0.86	1.63 - 1.66
COPPER PLATING	0.025 - 0.050	0.025 - 0.050
TIN PLATING	0.005 - 0.015	0.005 - 0.015



FOR PLATING AND HOLE SIZE SEE TABLE
 RECOMMENDED PC BOARD LAYOUT
 COMPONENT SIDE

- NOTES:
 1 BODY MAT'L: LIQUID CRYSTAL POLYMER 30% GLASS
 FLAME RETARDANT ACC. UL 94-V0
 2 TERMINAL MATERIAL: PHOSPHOR BRONZE
 3 SEE TA-0941 FOR APPLICATION TOOLING

PRODUCT NR:	PLATING	TERMINAL CONTACT AREA
85847-1Y2	0.8 μm GOLD OVER	1.3 μm Ni MIN.
85847-2Y2	2.0 μm GOLD OVER	1.3 μm Ni MIN.
85847-3Y2	1.3 μm GOLD OVER	1.3 μm Ni MIN.
85847-9Y2	0.8 μm GXT OVER	1.3 μm Ni MIN.

mat'l. code		Tolerances unless otherwise specified		CUSTOMER COPY		BERG ELECTRONICS	
ITF	SEE NOTE 1			projection		title	
A	H60134 MWE 951206	linear		⊕		5+2 RECEPTACLE	
B	H60642 DDB 961011	angles		mm		12 mm ASSEMBLY	
C	H70135 PMA 970225			scale		product family METRAL (tm) code	
D	H70358 JDE 970606	eng	R. VISSCHERS 950202	5:1		size/dwg no	
		chr	E. FEUEN 950202	A2		85847	
		apod	E. FEUEN 950202			sheet 1 of 1	
sheet index	revision	D					
		1					

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